

DSRC 5900MHz Ceramic Chip Antenna Part No: CA.51

Description:

5.9GHz DSRC Ceramic SMD Mount Chip Antenna

Features:

5850MHz to 5925MHz Peak Gain 2dBi Stable and Reliable Performance Linear Polarized & High Efficiency Low Profile, Compact Size Manufactured in an IATF16949 Approved Facility Dimensions: 1.6*0.8*0.3mm RoHS & REACH Compliant



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The Taoglas CA.51 is a ceramic chip antenna specifically designed for 5.9GHz DSRC applications. Primarily designated for vehicle safety applications, DSRC offers high-speed, low-latency wireless communication over short distances. The CA.51 exhibits high-efficiency in a miniature SMD mount ceramic antenna with a small footprint requirement. This ceramic chip antenna uses the main PCB as its ground plane, thereby increasing antenna efficiency and decreasing the assembly cost. It is tuned for different PCB sizes by simply changing the value of the matching circuit. At 1.6mm*0.8mm*0.3mm, it is one of the smallest antennas available worldwide. This antenna is delivered on tape and reel.

This antenna can be mounted with no performance degradation in either orientation if the antenna is soldered correctly via surface mounting. Please see the integration instructions section for further detail regarding the optimum way to integrate this antenna into your device.

Applications:

- IEEE 802.11p (WAVE- Wireless Access in the Vehicular Environment)
- DSRC (Dedicated Short-Range Communication) systems for the automotive industry

For support on how to integrate and test this antenna within your application, or for sample requests, contact your regional Taoglas Customer Services Team.



Specifications

2.

Antenna		
Frequency (MHz)	5850-5925 MHz	
	Efficiency (%)	
40 x 40 mm Ground Plane	57.08	
	Average Gain (dB)	
40 x 40 mm Ground Plane	-2.44 dB (typical)	
	Peak Gain (dBi)	
40 x 40 mm Ground Plane	2.87 dBi (typical)	
VSWR	2 max.	
Impedance (Ω)	50Ω	
Polarization	Linear	
Radiation Pattern	Omni	
Input Power(W)	2	
	Mechanical	
Dimensions (mm)	1.6 x 0.8 x 03	
Ground plane (mm)	40 x 40 (Recommended)	
Material	Ceramic	
	Environmental	
Temperature Range	-40°C to 85°C	
Temperature Coefficient of Frequency (ppm/°C)	0±20 max. (@-40°C to 85°C)	
Humidity	Non-condensing 65°C 95% RH	
Moisture Sensitivity Level	3 (168 Hours)	



















4. Radiation Patterns



Test Setup – Antenna on Evaluation Board







-30

-40

dB

-30

-35

-40

dB





*Taoglas is able to provide CAD drawing file to customers for evaluation.







6.1 Schematic Symbol and Pin Definition

The circuit symbol for the antenna is shown below. The antenna has 3 pins with all three pins as functional.

Pin	Description
1	RF Feed
2	Fine Tuning Element
3	Ground





6.2 Antenna Integration

For any given PCB size, the antenna should ideally be placed in the corner of the PCB, to take advantage of the ground plane. Optimized matching components can be placed as shown.







6.3 PCB Layout

The footprint and clearance on the PCB must meet the layout drawing in section (Footprint Drawing). Note the placement of the optimized components. L1 is placed as close as possible to the RF feed (pad 1) within RF Trace with C5 then placed tightly in series after that. C2 is placed as close as possible to the Fine-Tuning Element feed (pad 3) within the copper keep out area with C3 then placed tightly in series after that. C1 & C4 are optional components but the footprints are recommended in case it is needed.





Topside



6.4 PCB Clearance

Below shows the antenna footprint and clearance through ALL layers on the PCB. Only the antenna pads and connections to feed and GND are present within this clearance area (marked RED). The clearance area extends to 2.8mm in length and 6mm in width from the corner of the PCB. This clearance area includes the bottom side and ALL internal layers on the PCB.



Topside



Bottom Side





Topside



Bottom Side

6.5



6.6 Evaluation Board Matching Circuit

Matching Components with the CA.51 are required for the antenna to have optimal performance on the evaluation board, located outside of the ground plane in the space specified in the above images. Additional matching components may be necessary for your device, so we recommend incorporating extra component footprints, forming a "pi" network, between the antenna module and the edge of the ground plane.

Designator	Туре	Value	Manufacturer	Manufacturer Part Number
C1, C4	Capacitor	Not Fitted	-	-
C2	Capacitor	6.8pF	Murata	GRM0335C1H6R8DA01D
C3	Capacitor	5.6pF	Murata	GRM0335C1E5R6CA01D
C5	Capacitor	2.7pF	Murata	GCM1555C1H2R7CA16D
L1	Inductor	2.2nH	TDK	MLK1005S2N2ST000





Soldering Conditions



The CA.51 can be assembled by following the recommended soldering temperatures are as follows:

*Temperatures listed within a tolerance of +/- 10º C

Smaller components are typically mounted on the first pass, however, we do advise mounting the CA.51 when placing larger components on the board during subsequent reflows.

Note: Soldering flux classified ROLO under IPC J-STD-004 is recommended.

7.



8. Packaging











5000 pcs CA.51 reel Dimensions - 180*180*11mm Weight - 159.8g A (a) (1) 225mm 50,000 pcs CA.51 / 10 Reel in small box Dimensions - 193*225*195mm Weight - 1.6Kg 193mm 195mm 2 small boxes, 100,000 pcs in one carton Carton Dimensions - 247*405*225mm Weight - 3.2Kg 225mm 247mm 405mm Pallet Dimensions 1200*1000*1310mm 40 Cartons per Pallet 1310mm 8 Cartons per layer 5 Layers

1200mm



	Changelog for the datasheet		
SPE-17-8-032 – CA.51			
	Revision: F (Current	Version)	
	Date:	2023-10-16	
	Changes:	Updated specifications	
	Changes Made by:	Cesar Sousa	

Previous Revisions

Revision: E		
Date:	2023-09-14	
Changes:	Updated solder reflow information and antenna footprint	
Changes Made by:	Cesar Sousa	

Revision: D		
Date:	2023-03-22	
Changes:	Integration Guide Added	
Changes Made by:	Cesar Sousa	

Revision: C		
Date:	2021-10-04	
Changes:	Format Change, MSL	
Changes Made by:	Erik Landi	

Revision: B		
Date:	2019-10-25	
Changes:	Updated to C-V2X	
Changes Made by:	Jack Conroy	

Revision: A (Original First Release)		
Date:	2017-05-22	
Notes:	Initial Release	
Author:	STAFF	



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